# **5 V Triple PECL Input to -5 V ECL Output Translator**

#### **Description**

The MC100EL91 is a triple PECL input to ECL output translator. The device receives standard voltage differential PECL signals, determined by the  $V_{CC}$  supply level, and translates them to differential -5 V ECL output signals. (For translation of LVPECL to -3.3 V ECL output, see MC100LVEL91.)

To accomplish the level translation, the EL91 requires three power rails. The  $V_{CC}$  supply should be connected to the positive supply, and the  $V_{EE}$  pin should be connected to the negative power supply. The GND pins are connected to the system ground plane. Both  $V_{EE}$  and  $V_{CC}$  should be bypassed to ground via 0.01  $\mu F$  capacitors.

Under open input conditions, the  $\overline{D}$  input will be biased at  $V_{CC}/2$  and the D input will be pulled to GND. This condition will force the Q output to a low, ensuring stability.

The  $V_{BB}$  pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to  $V_{BB}$  as a switching reference voltage.  $V_{BB}$  may also rebias AC coupled inputs. When used, decouple  $V_{BB}$  and  $V_{CC}$  via a 0.01  $\mu F$  capacitor and limit current sourcing or sinking to 0.5 mA. When not used,  $V_{BB}$  should be left open.

#### **Features**

- 670 ps Typical Propagation Delay
- ESD Protection: >2 kV Human Body Model
- The 100 Series Contains Temperature Compensation
- Operating Range:  $V_{CC} = 4.75 \text{ V}$  to 5.5 V;

$$V_{EE} = -4.2 \text{ V to } -5.5 \text{ V; GND} = 0 \text{ V}$$

- Internal Input Pulldown Resistors
- Q Output will Default LOW with Inputs Open or at GND
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 1
   For Additional Information, see Appl

For Additional Information, see Application Note AND8003/D

- Flammability Rating: UL 94 V-0 @ 0.125 in, Oxygen Index: 28 to 34
- Transistor Count = 282 devices
- Pb-Free Package is Available\*



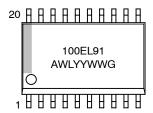
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SO-20 WB DW SUFFIX CASE 751D

#### **MARKING DIAGRAM\***



A = Assembly Location

WL = Wafer Lot YY = Year

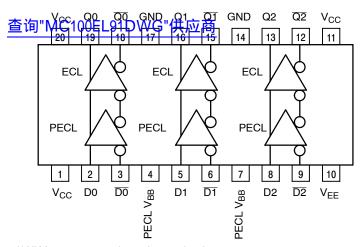
WW = Work Week
G = Pb-Free Package

\*For additional marking information, refer to Application Note AND8002/D.

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



**Table 1. PIN DESCRIPTION** 

PIN	FUNCTION
Dn, Dn Qn, Qn PECL V <sub>BB</sub> V <sub>CC</sub> V <sub>EE</sub> GND	PECL Inputs ECL Outputs PECL Reference Voltage Output Positive Supply Negative Supply Ground

Warning: All  $V_{CC}$ ,  $V_{EE}$ , and GND pins must be externally connected to Power Supply to guarantee proper operation.

Figure 1. 20-Lead Pinout (Top View) and Logic Diagram

**Table 2. MAXIMUM RATINGS** 

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V <sub>CC</sub>	PECL Power Supply	GND = 0 V		8 to 0	V
V <sub>EE</sub>	NECL Power Supply	GND = 0 V		-8 to 0	V
VI	PECL Input Voltage	GND = 0 V	GND = 0 V $V_1 \le V_{CC}$		V
I <sub>out</sub>	Output Current	Continuous Surge		50 100	mA mA
I <sub>BB</sub>	PECL V <sub>BB</sub> Sink/Source			± 0.5	mA
T <sub>A</sub>	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			−65 to +150	°C
θJA	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	SOIC-20 WB SOIC-20 WB	90 60	°C/W
θJC	Thermal Resistance (Junction-to-Case)	Standard Board	SOIC-20 WB	30 to 35	°C/W
T <sub>sol</sub>	Wave Solder Pb Pb-Free	<2 to 3 sec @ 248°C <2 to 3 sec @ 260°C		265 265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

<sup>\*\*</sup>All  $V_{CC}$  pins are tied together on the die.

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	, , , , , , , , , , , , , , , , , , ,		-40°C		25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>CC</sub>	V <sub>CC</sub> Power Supply Current			11		6	11			11	mA
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended)	3835		4120	3835		4120	3835		4120	mV
V <sub>IL</sub>	Input LOW Voltage (Single-Ended)	3190		3525	3190		3525	3190		3525	mV
PECL V <sub>BB</sub>	Output Voltage Reference	3.62		3.74	3.62		3.74	3.62		3.74	V
VIHCMR	Input HIGH Voltage Common Mode Range (Differential) (Note 2)  V <sub>PP</sub> < 500 mV  V <sub>PP</sub> ≥ 500 mV	1.3 1.5		4.8 4.8	1.2 1.4		4.8 4.8	1.2 1.4		4.8 4.8	٧
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current	0.5			0.5			0.5			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 1. Input parameters vary 1:1 with  $V_{CC}$ .  $V_{CC}$  = +4.75 V to +5.2 V,  $V_{EE}$  = -4.20 V to -5.5 V.
- 2. V<sub>IHCMR</sub> min varies 1:1 with GND. V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>.

Table 4. NECL OUTPUT DC CHARACTERISTICS V<sub>CC</sub>= 5.0 V to 5.0 V; V<sub>EE</sub>= -5.0 V; GND= 0 V (Note 3)

		−40°C			25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	V <sub>EE</sub> Power Supply Current			28		22	28			30	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 4)	-1085	-1005	-880	-1025	-955	-880	-1025	-955	-880	mV
V <sub>OL</sub>	Output LOW Voltage (Note 4)	-1830	-1695	-1555	-1810	-1705	-1620	-1810	-1705	-1620	mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 3. Output parameters vary 1:1 with GND.  $V_{CC}$  = +4.75 V to +5.2 V,  $V_{EE}$  = -4.20 V to -5.5 V.
- 4. Outputs are terminated through a 50  $\Omega$  resistor to GND 2.0 V

THE STANCE 5.0 V; VEE = -5.0 V; GND = 0 V (Note 8).

		-40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>max</sub>	Maximum Toggle Frequency		700			700			700		MHz
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay D to Q Differential Single-Ended.	540 490	640 640	740 790	570 520	670 670	770 820	610 560	710 710	810 860	ps
tskew	Skew Output-to-Output (Note 5) Part-to-Part (Differential) (Note 5) Duty Cycle (Differential) (Note 6)		40 25	100 200		40 25	100 200		40 25	100 200	ps
t <sub>JITTER</sub>	Random Clock Jitter @ 700 MHz		1.2			1.2			1.2		pS(RMS)
V <sub>PP</sub>	Input Swing (Note 7)	200		1000	200		1000	200		1000	mV
t <sub>r</sub> t <sub>f</sub>	Output Rise/Fall Times Q (20% – 80%)	270	400	530	270	400	530	270	400	530	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 5. Skews are valid across specified voltage range, part-to-part skew is for a given temperature.

- Only cycle skew is the difference between a t<sub>PLH</sub> and t<sub>PHL</sub> propagation delay through a device.
   V<sub>PP</sub>(min) is the minimum input swing for which AC parameters are guaranteed. The device has a DC gain of ≈40.
   V<sub>CC</sub> = +4.75 V to +5.2 V, V<sub>EE</sub> = -4.20 V to -5.5 V. Outputs are terminated through a 50 Ω resistor to GND 2.0 V.

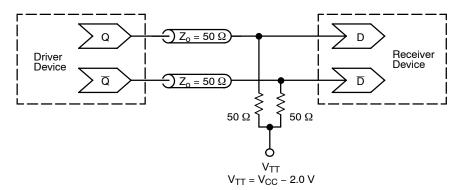


Figure 2. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D - Termination of ECL Logic Devices.)

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Device	Package	Shipping <sup>†</sup>
MC100EL91DW	SO-20 WB	38 Units / Rail
MC100EL91DWG	SO-20 WB (Pb-Free)	38 Units / Rail
MC100EL91DWR2	SO-20 WB	1000 / Tape & Reel
MC100EL91DWR2G	SO-20 WB (Pb-Free)	1000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **Resource Reference of Application Notes**

AN1405/D - ECL Clock Distribution Techniques

AN1406/D - Designing with PECL (ECL at +5.0 V)

AN1503/D - ECLinPS™ I/O SPiCE Modeling Kit

AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL

AN1672/D - The ECL Translator Guide

AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

AND8020/D - Termination of ECL Logic Devices

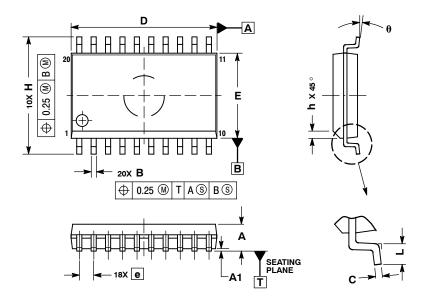
AND8066/D - Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

## 查询"MC100EL91DWG"供应商

#### PACKAGE DIMENSIONS

**SO-20 WB DW SUFFIX** CASE 751D-05 **ISSUE G** 



#### NOTES

- 1. DIMENSIONS ARE IN MILLIMETERS.
  2. INTERPRET DIMENSIONS AND TOLERANCES
  PER ASME Y14.5M, 1994.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 PER SIDE. DIMENSION B DOES NOT INCLUDE DAMBAR
- PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS							
DIM	MIN	MAX						
Α	2.35	2.65						
A1	0.10	0.25						
В	0.35	0.49						
С	0.23	0.32						
D	12.65	12.95						
Е	7.40	7.60						
е	1.27	BSC						
Н	10.05	10.55						
h	0.25	0.75						
L	0.50	0.90						
θ	0 °	7 °						

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